
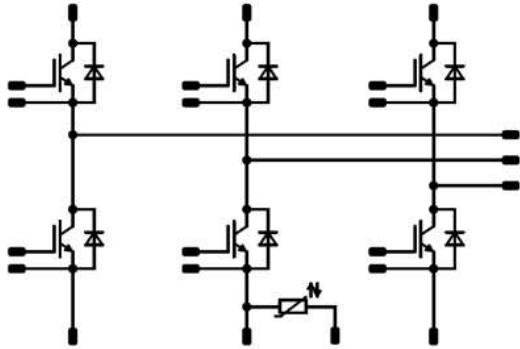




Vincotech

<i>flow</i> PACK 2	1200 V / 100 A
<div style="background-color: #ccc; padding: 2px; margin-bottom: 5px;">Features</div> <ul style="list-style-type: none"> Mitsubishi Generation 6.1 (1200V) technology for low saturation losses and improved EMC behavior Compact and low inductive design Integrated temperature sensor 	<div style="background-color: #ccc; padding: 2px; margin-bottom: 5px;">flow 2 17mm housing</div> 
<div style="background-color: #ccc; padding: 2px; margin-bottom: 5px;">Target applications</div> <ul style="list-style-type: none"> Industrial drives 	<div style="background-color: #ccc; padding: 2px; margin-bottom: 5px;">Schematic</div> 
<div style="background-color: #ccc; padding: 2px; margin-bottom: 5px;">Types</div> <ul style="list-style-type: none"> 30-P2126PA100NB-L289F69Y 	

Maximum Ratings

$T_j=25^{\circ}\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current	I_C	$T_j = T_{jmax}$ $T_s = 80^{\circ}\text{C}$	111	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	200	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^{\circ}\text{C}$	258	W
Gate-emitter voltage	V_{CES}		± 20	V
Maximum Junction Temperature	T_{jmax}		175	$^{\circ}\text{C}$



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Parameter	Symbol	Conditions	Value	Unit
Inverter Diode				
Peak Repetitive Reverse Voltage	V_{RRM}		1200	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_h = 80^\circ\text{C}$	82	A
Repetitive peak forward current	I_{FRM}		200	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_h = 80^\circ\text{C}$	164	W
Maximum Junction Temperature	T_{jmax}		175	$^\circ\text{C}$

Module Properties

Parameter	Symbol	Conditions	Value	Unit
Thermal Properties				
Storage temperature	T_{stg}		-40...+125	$^\circ\text{C}$
Operation Junction Temperature	T_{jop}		-40...+($T_{jmax} - 25$)	$^\circ\text{C}$

Isolation Properties

Isolation voltage	V_{isol}	DC voltage	$t_p=2s$	4000	V
Creepage distance				min 12,7	mm
Clearance				min 12,7	mm
Comparative Tracking Index	CTI			>200	



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Characteristic Values

Inverter Switch

Parameter	Symbol	Conditions				Value			Unit
		V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{CE}$			0,01	25 125	5,4	6	6,6	V
Collector-emitter saturation voltage	V_{CEsat}		15		100	25 125 150	1,2	1,77 2,05 2,11	2,2	V
Collector-emitter cut-off current	I_{CES}		0	1200		25 125			300	μA
Gate-emitter leakage current	I_{GES}		20	0		25 125			1000	nA
Internal gate resistance	r_g							none		Ω
Input capacitance	C_{ies}							6200		pF
Output capacitance	C_{oes}	f=100 KHz	0	10	25			680		
Reverse transfer capacitance	C_{res}							74		
Gate charge	Q_g		15	600	100	25		210		nC

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	Phase-Change Material $\lambda=3,4W/mK$						0,37		K/W
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IGBT Switching

Turn-on delay time	$t_{d(on)}$					25 125 150		63 63 64		ns
Rise time	t_r	$R_{goff} = 4 \Omega$ $R_{gon} = 4 \Omega$				25 125 150		7 9 9		
Turn-off delay time	$t_{d(off)}$		±15	600	100	25 125 150		146 190 202		
Fall time	t_f					25 125 150		55 76 81		
Turn-on energy (per pulse)	E_{on}	$Q_{fFWD} = 8,2 \mu C$ $Q_{rFWD} = 19,5 \mu C$ $Q_{fFWD} = 22,2 \mu C$				25 125 150		2,002 3,517 4,014		
Turn-off energy (per pulse)	E_{off}					25 125 150		4,777 7,481 8,253		



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Inverter Diode

Parameter	Symbol	Conditions					Value			Unit
		V_r [V]	I_F [A]	T_j [°C]	Min	Typ	Max			

Static

Forward voltage	V_F				100	25 125 150		2,57 2,31 2,19	3,3	V
Reverse leakage current	I_r			1200		25 150			50 -	μ A

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	Phase-Change Material $\lambda=3,4$ W/mK						0,58		K/W
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FWD Switching

Peak recovery current	I_{RRM}					25 125 150		160 184 191		A
Reverse recovery time	t_{rr}					25 125 150		98 136 143		ns
Recovered charge	Q_r	$di/dt = 13103$ A/ μ s $di/dt = 10356$ A/ μ s $di/dt = 9265$ A/ μ s	± 15	600	100	25 125 150		8,215 19,527 22,208		μ C
Reverse recovered energy	E_{rec}					25 125 150		3,929 9,926 11,221		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		13494 5569 4331		A/ μ s

Thermistor

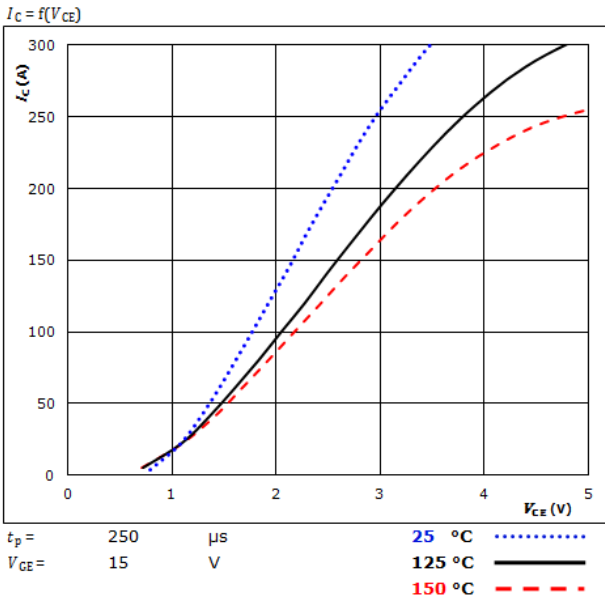
Parameter	Symbol	Conditions				Value			Unit
		V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	

Rated resistance	R					25		22		k Ω
Deviation of R100	$\Delta_{R/R}$	R100=1486 Ω				100	-12		+12	%
Power dissipation	P					25		200		mW
Power dissipation constant						25		2		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 3\%$				25		3950		K
B-value	$B_{(25/100)}$	Tol. $\pm 3\%$				25		3998		K
Vincotech NTC Reference									B	

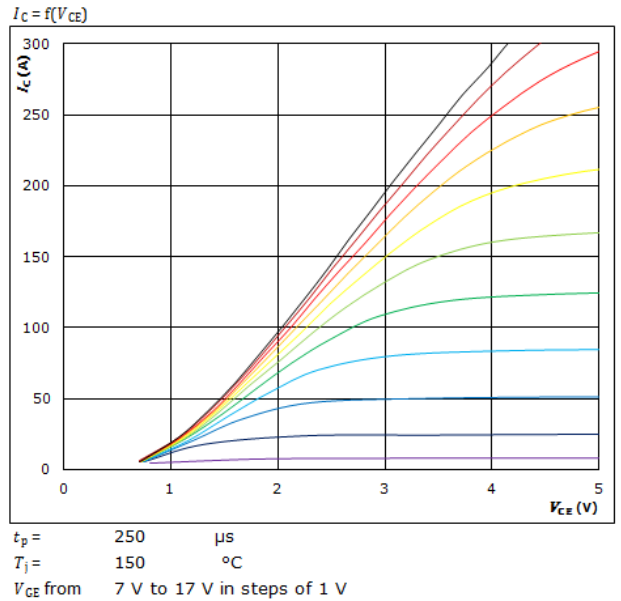


Inverter Switch Characteristics

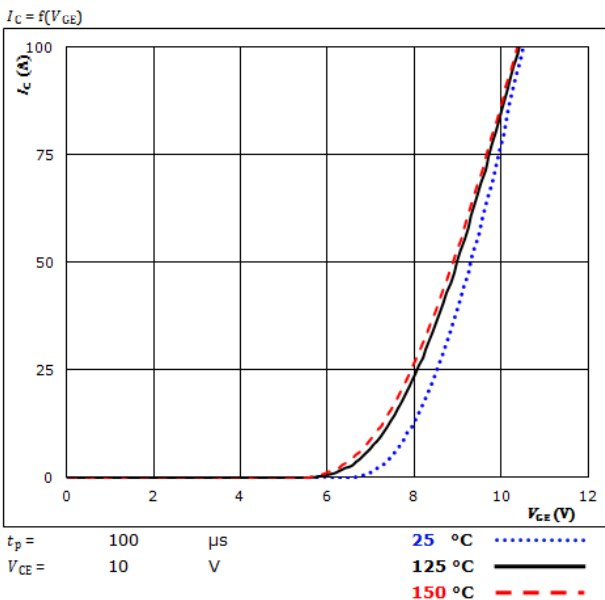
Typical output characteristics IGBT



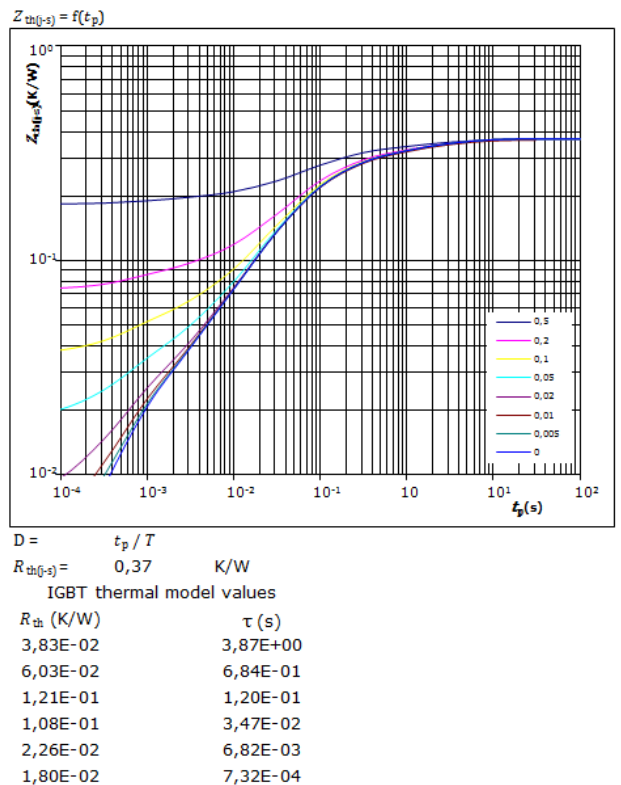
Typical output characteristics IGBT



Typical transfer characteristics IGBT



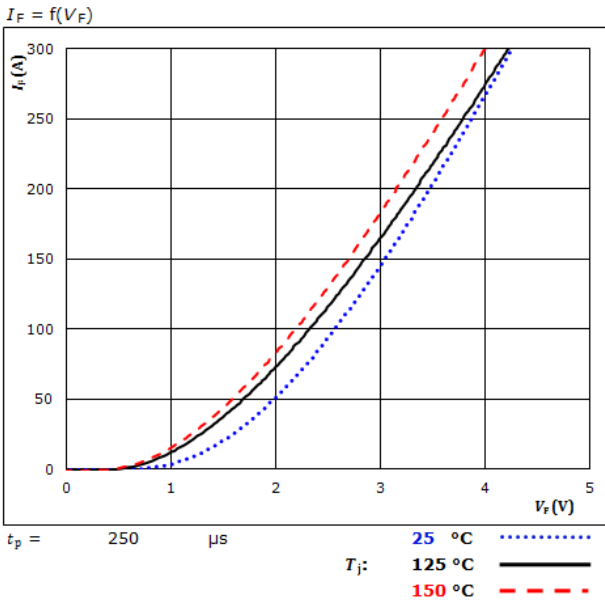
Transient Thermal Impedance as function of Pulse duration IGBT



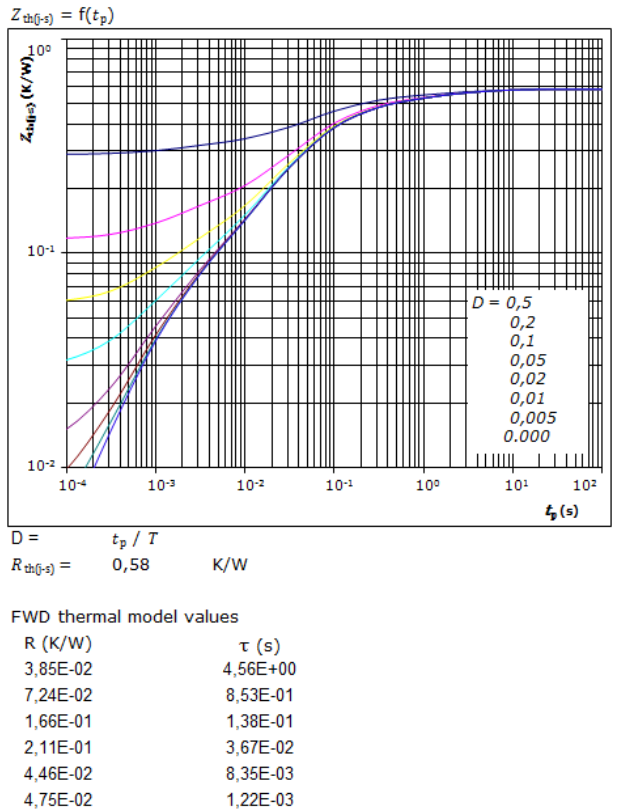


Inverter Diode Characteristics

Typical forward characteristics FWD



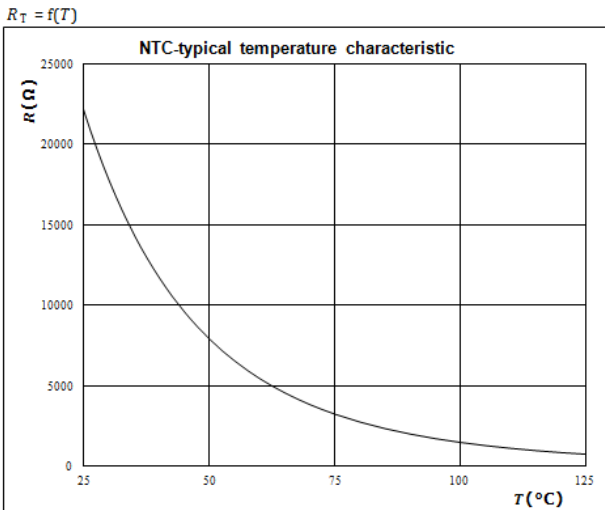
Transient thermal impedance as a function of pulse width FWD



Thermistor Characteristics

Thermistor typical temperature characteristic

Typical NTC characteristic as a function of temperature

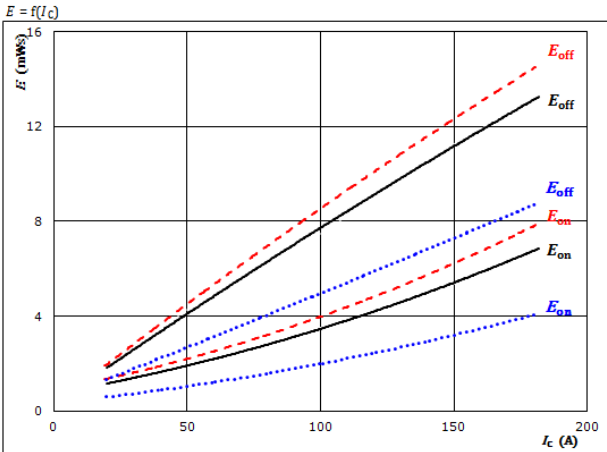




Inverter Switching Characteristics

Figure 1. IGBT

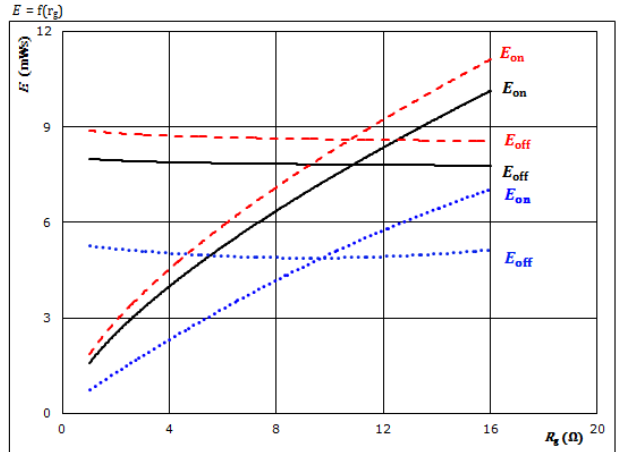
Typical switching energy losses as a function of collector current



With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω
 T_j : 25 °C (dotted), 125 °C (solid), 150 °C (dashed)

Figure 2. IGBT

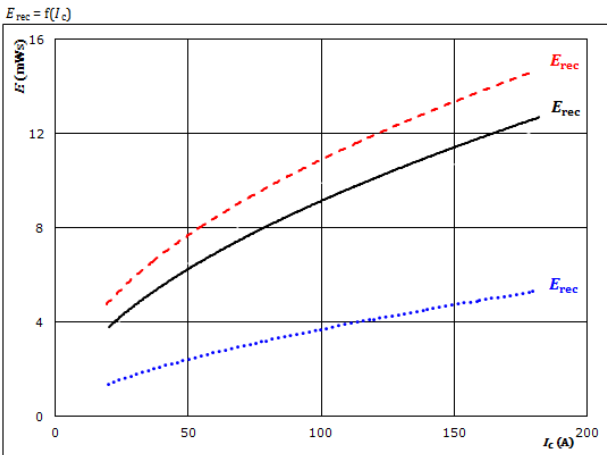
Typical switching energy losses as a function of gate resistor



With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 100$ A
 T_j : 25 °C (dotted), 125 °C (solid), 150 °C (dashed)

Figure 3. FWD

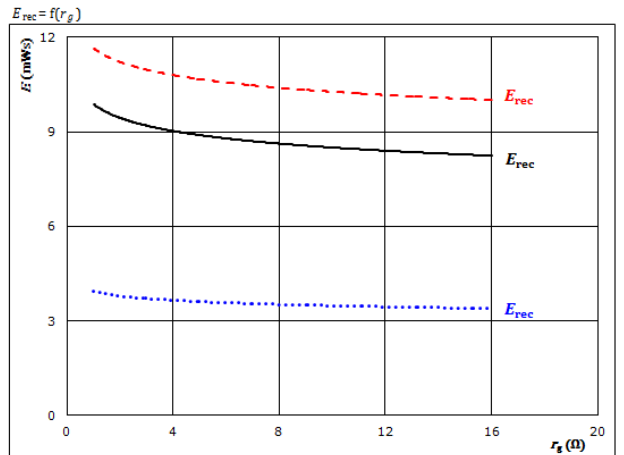
Typical reverse recovered energy loss as a function of collector current



With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω
 T_j : 25 °C (dotted), 125 °C (solid), 150 °C (dashed)

Figure 4. FWD

Typical reverse recovered energy loss as a function of gate resistor



With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 100$ A
 T_j : 25 °C (dotted), 125 °C (solid), 150 °C (dashed)



Inverter Switching Characteristics

Figure 5. IGBT

Typical switching times as a function of collector current

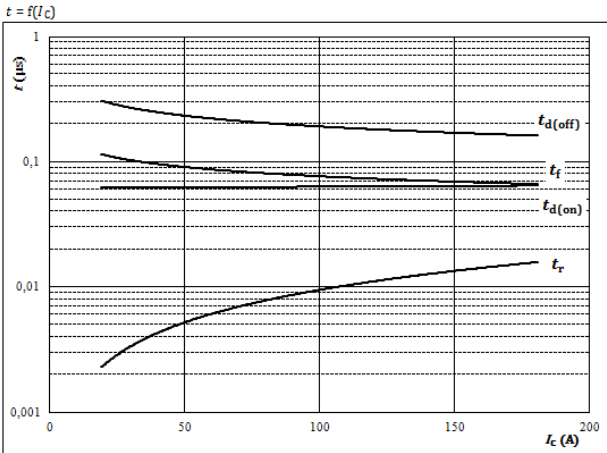


Figure 6. IGBT

Typical switching times as a function of gate resistor

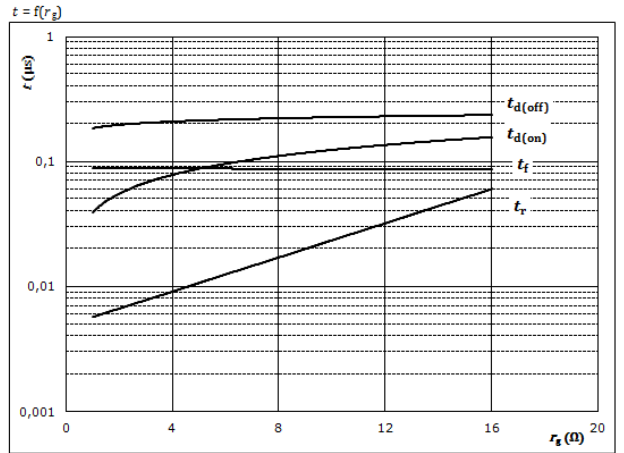


Figure 7. FWD

Typical reverse recovery time as a function of collector current

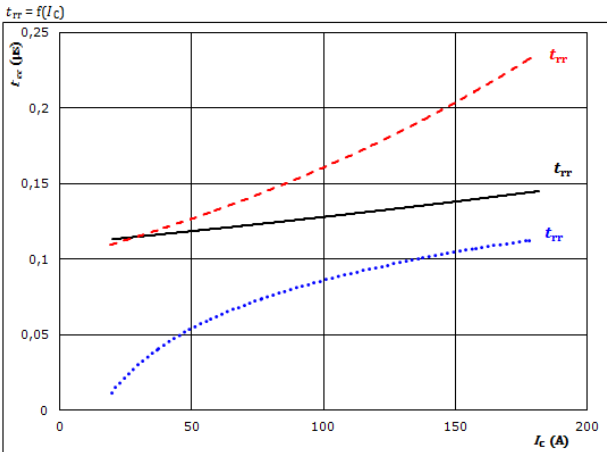
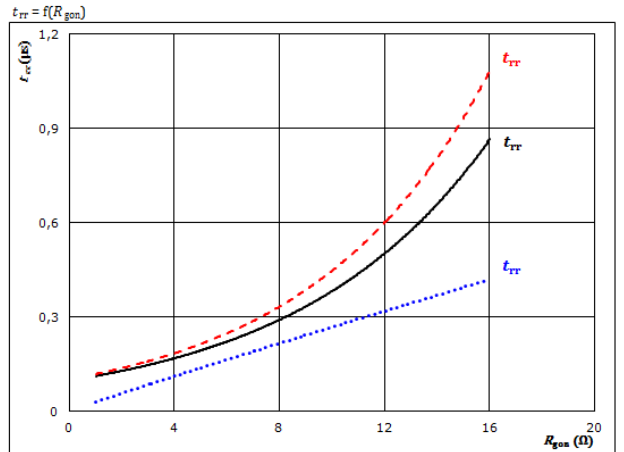


Figure 8. FWD

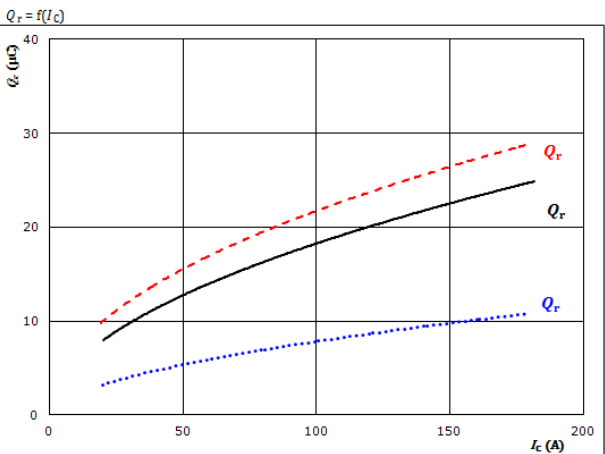
Typical reverse recovery time as a function of IGBT turn on gate resistor





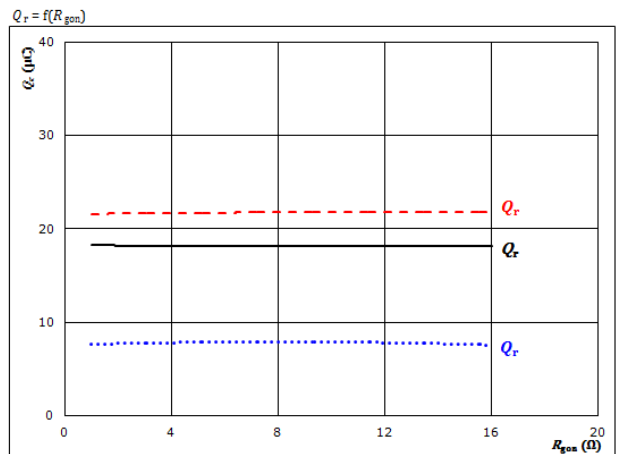
Inverter Switching Characteristics

Figure 9. FWD
Typical recovered charge as a function of collector current



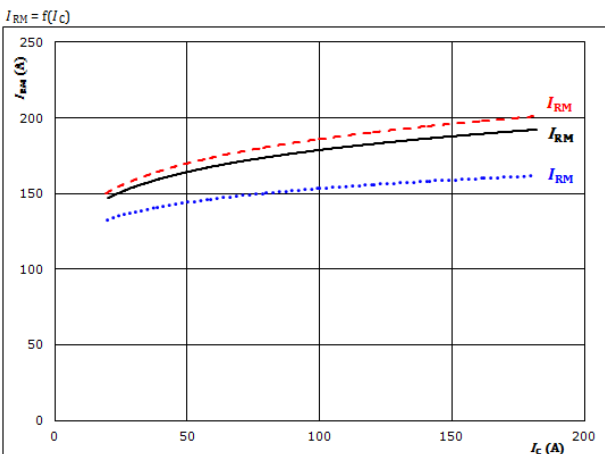
At $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω
 T_j : 25 °C (dotted), 125 °C (solid), 150 °C (dashed)

Figure 10. FWD
Typical recovered charge as a function of IGBT turn on gate resistor



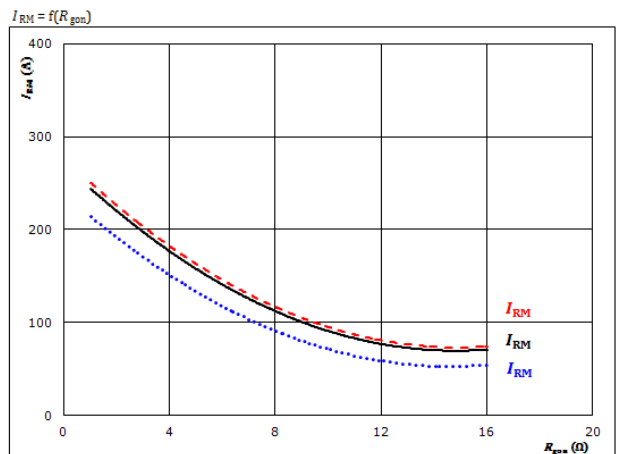
At $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_c = 100$ A
 T_j : 25 °C (dotted), 125 °C (solid), 150 °C (dashed)

Figure 11. FWD
Typical peak reverse recovery current as a function of collector current



At $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω
 T_j : 25 °C (dotted), 125 °C (solid), 150 °C (dashed)

Figure 12. FWD
Typical peak reverse recovery current as a function of IGBT turn on gate resistor



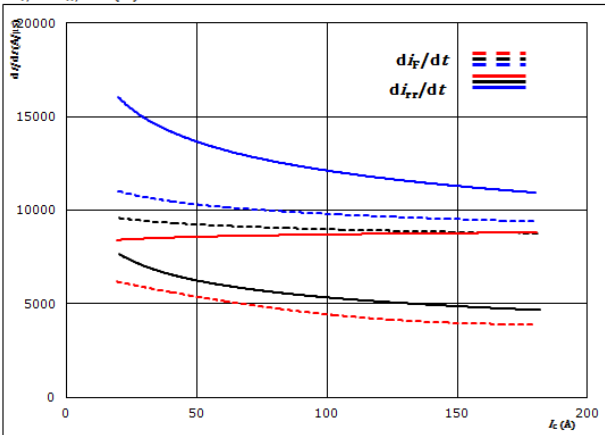
At $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_c = 100$ A
 T_j : 25 °C (dotted), 125 °C (solid), 150 °C (dashed)



Inverter Switching Characteristics

Figure 13. FWD

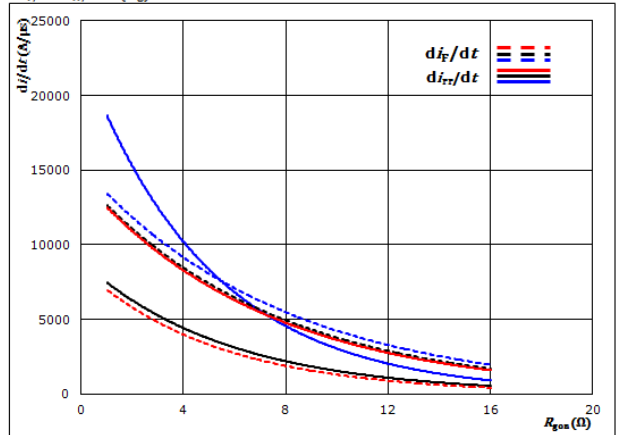
Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_F/dt, di_{rr}/dt = f(I_C)$



At $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω
 $T_j = 25$ °C
 125 °C
 150 °C

Figure 14. FWD

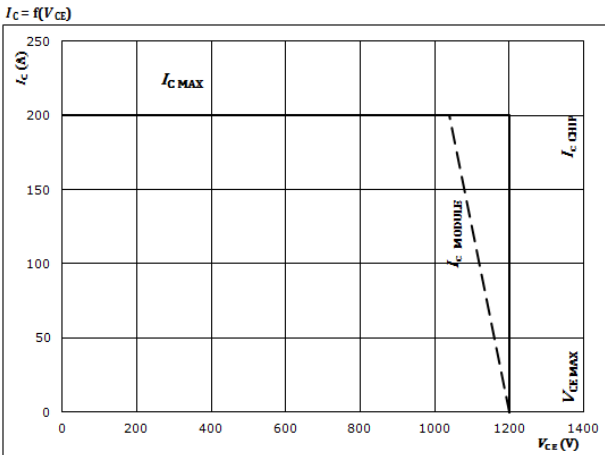
Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor
 $di_F/dt, di_{rr}/dt = f(R_g)$



At $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 100$ A

Figure 15. IGBT

Reverse bias safe operating area



At $T_j = 175$ °C
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

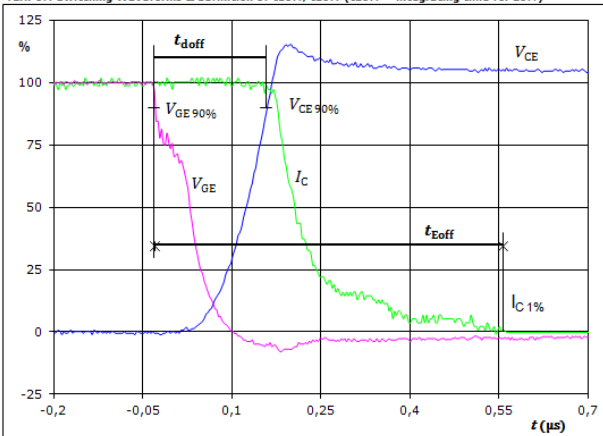


Inverter Switching Definitions

General conditions

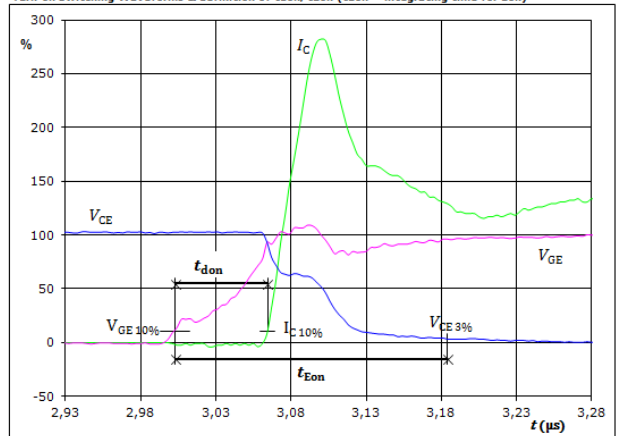
T_j	=	125 °C
R_{gon}	=	4 Ω
R_{goff}	=	4 Ω

Figure 1. IGBT
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})



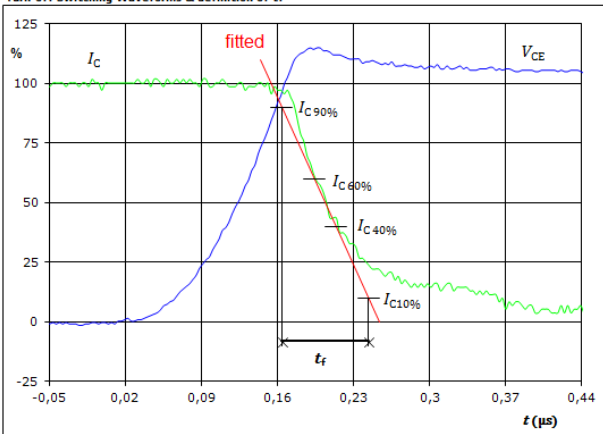
$V_{CE}(0\%) =$	-15	V
$V_{CE}(100\%) =$	15	V
$I_C(100\%) =$	600	A
$I_C(100\%) =$	100	A
$t_{doff} =$	0,19	μs
$t_{Eoff} =$	0,588	μs

Figure 2. IGBT
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})



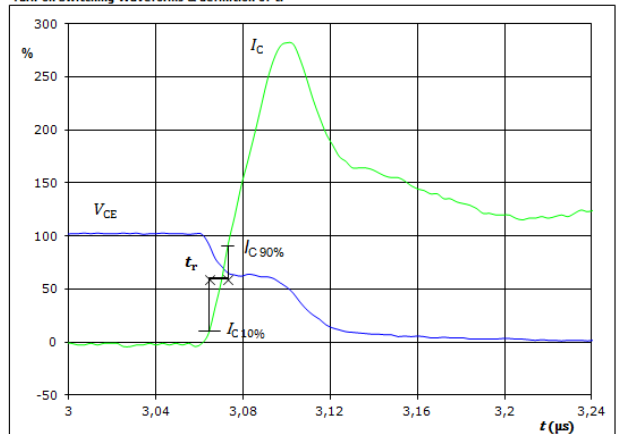
$V_{CE}(0\%) =$	-15	V
$V_{CE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	100	A
$t_{don} =$	0,063	μs
$t_{Eon} =$	0,18	μs

Figure 3. IGBT
Turn-off Switching Waveforms & definition of t_f



$V_C(100\%) =$	600	V
$I_C(100\%) =$	100	A
$t_f =$	0,076	μs

Figure 4. IGBT
Turn-on Switching Waveforms & definition of t_r



$V_C(100\%) =$	600	V
$I_C(100\%) =$	100	A
$t_r =$	0,009	μs



Inverter Switching Definitions

Figure 5. IGBT

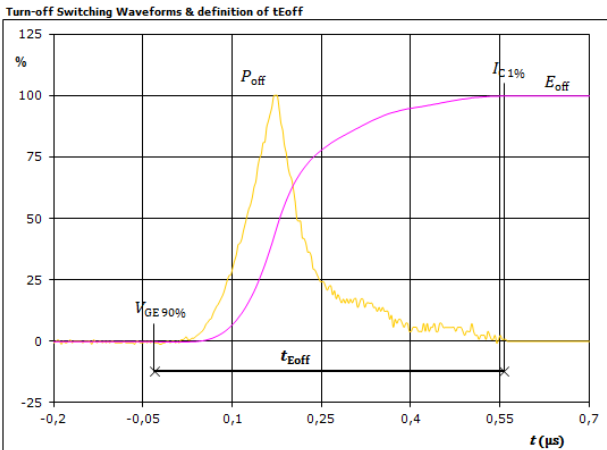


Figure 6. IGBT

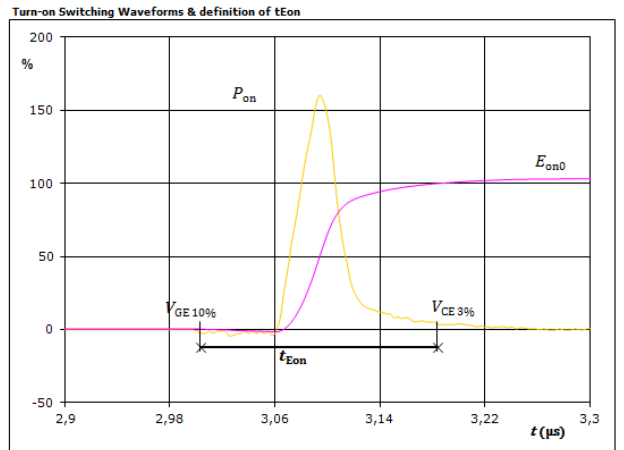
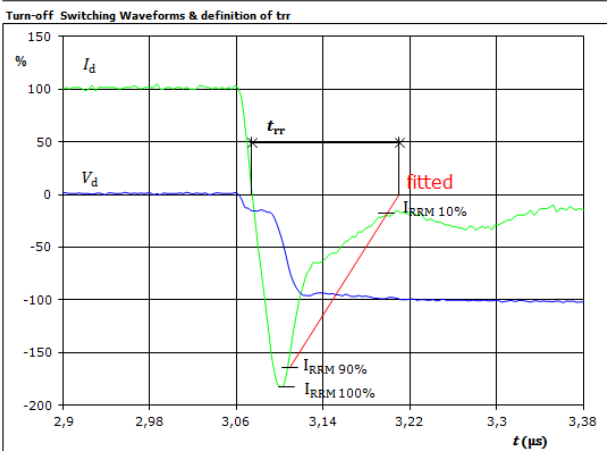


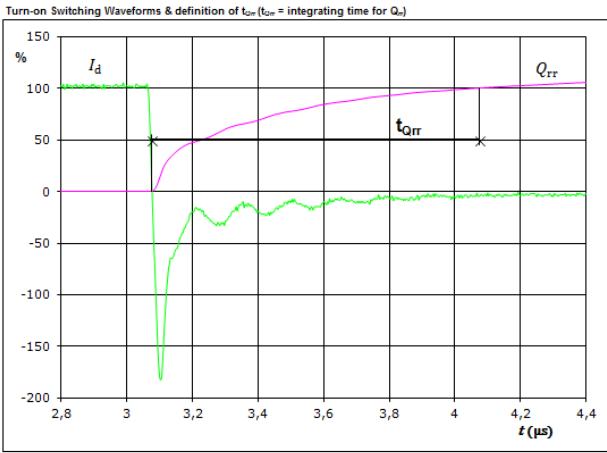
Figure 7. FWD





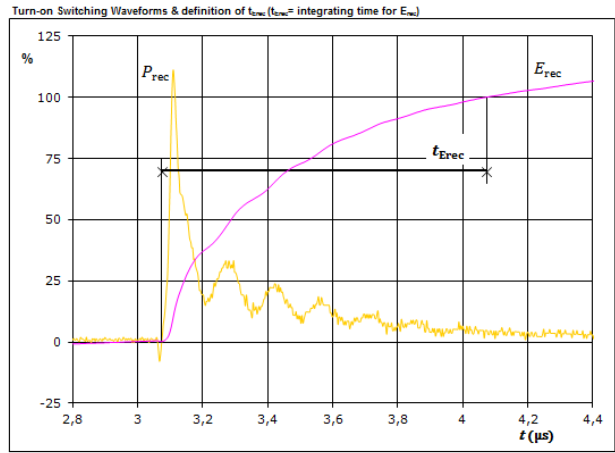
Inverter Switching Definitions

Figure 8. FWD



I_d (100%) = 100 A
 Q_{rr} (100%) = 19,53 μC
 t_{Qrr} = 1,00 μs

Figure 9. FWD



P_{rec} (100%) = 59,93 kW
 E_{rec} (100%) = 9,93 mJ
 t_{Erec} = 1,00 μs



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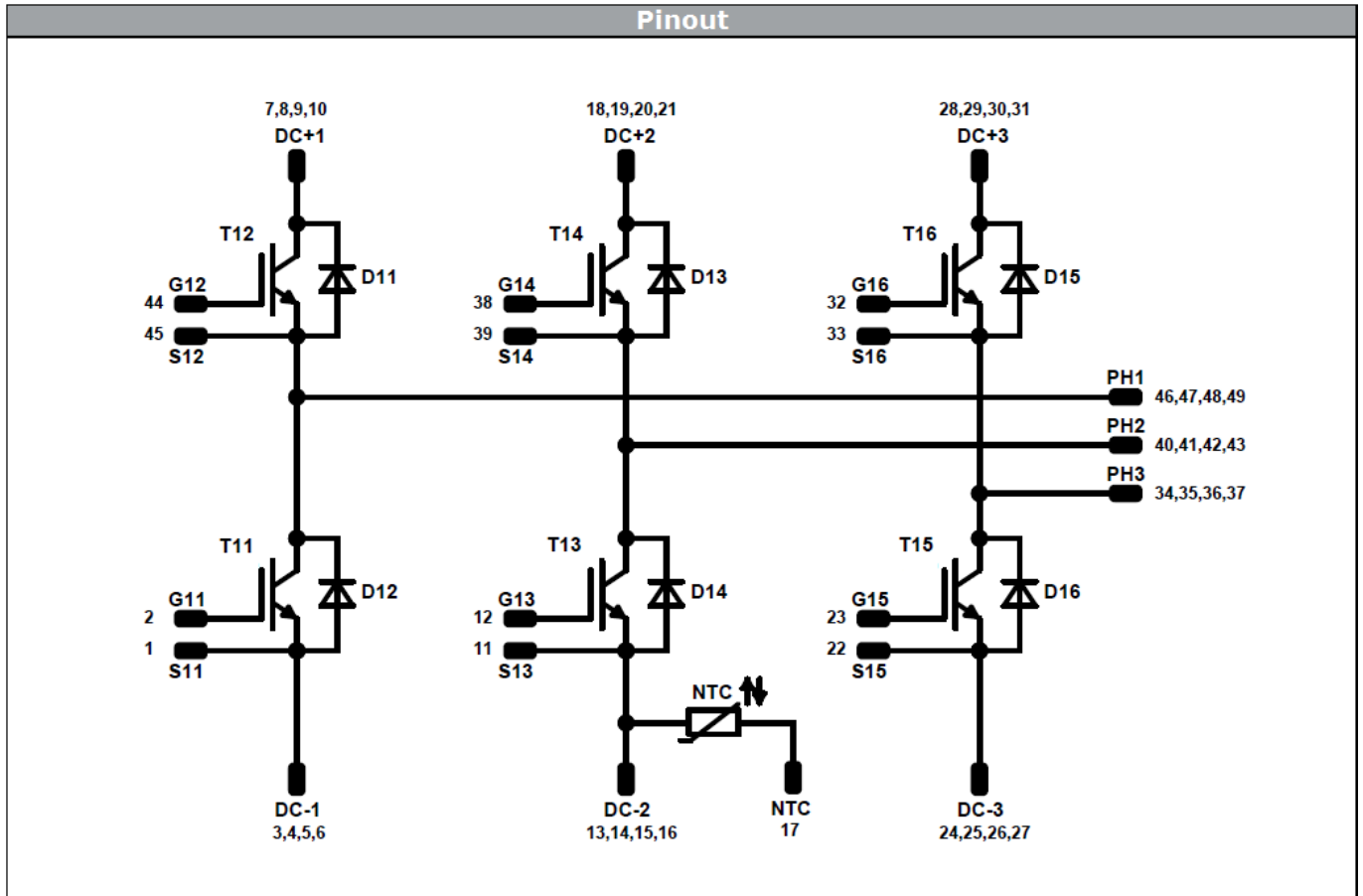
Ordering Code & Marking			
Version	Ordering Code	in DataMatrix as	in packaging barcode as
without thermal paste 17mm housing	30-P2126PA100NB-L289F69Y	L289F69Y	L289F69Y
with thermal paste 17mm housing	30-P2126PA100NB-L289F69Y-/3/	L289F69Y	L289F69Y-/3/

NN-NNNNNNNNNNNN NNNNNNNN WWYY UL Vinco LLLLL SSSS		Text	Name	Date code	UL & Vinco	Lot	Serial
			NN-NNNNNNNNNNNN-NNNNNNNN	WWYY	UL Vinco	LLLLL	SSSS
Datamatrix		Type&Ver	Lot number	Serial	Date code		
		TTTTTTW	LLLLL	SSSS	WWYY		

Outline							
Pin table [mm]				Pin table [mm]			
Pin	X	Y	Function	Pin	X	Y	Function
1	0,9	0	S11	30	68,5	0	DC+3
2	0,9	3	G11	31	68,5	2,7	DC+3
3	3,9	0	DC-1	32	64,7	36	G16
4	3,9	2,7	DC-1	33	61,7	36	S16
5	3,9	5,4	DC-1	34	58,7	36	PH3
6	6,6	0	DC-1	35	56	36	PH3
7	15,2	0	DC+1	36	53,3	36	PH3
8	15,2	2,7	DC+1	37	50,6	36	PH3
9	17,9	0	DC+1	38	39,4	36	G14
10	17,9	2,7	DC+1	39	36,4	36	S14
11	26,2	0	S13	40	33,4	36	PH2
12	26,2	3	G13	41	30,7	36	PH2
13	29,2	0	DC-2	42	28	36	PH2
14	29,2	2,7	DC-2	43	25,3	36	PH2
15	29,2	5,4	DC-2	44	14,1	36	G12
16	31,9	0	DC-2	45	11,1	36	S12
17	32,2	4,05	NTC	46	8,1	36	PH1
18	40,5	0	DC+2	47	5,4	36	PH1
19	40,5	2,7	DC+2	48	2,7	36	PH1
20	43,2	0	DC+2	49	0	36	Ph1
21	43,2	2,7	DC+2				
22	51,5	0	S15				
23	51,5	3	G15				
24	54,5	0	DC-3				
25	54,5	2,7	DC-3				
26	54,5	5,4	DC-3				
27	57,2	0	DC-3				
28	65,8	0	DC+3				
29	65,8	2,7	DC+3				



Vincotech



Identification					
ID	Component	Voltage	Current	Function	Comment
T11,T12,T13 T14,T15,T16	IGBT	1200V	100A	Inverter Switch	2*CH0050C-1200S002
D11,D12,D13 D14,D15,D16	FWD	1200V	100A	Inverter Diode	CH0100R-1200S002
NTC	NTC	-	-	Thermistor	



Packaging instruction					
Standard packaging quantity (SPQ)	42	>SPQ	Standard	<SPQ	Sample

Handling instruction	
Handling instructions for <i>flow</i> 2 packages see vincotech.com website.	

Document No.:	Date:	Modification:	Pages
30-P2126PA100NB-L289F69Y-D2-14	29 May. 2015		

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.